506650787 05/07/2021

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT6697598

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
HAMED PEZESHKI	04/26/2021
TAO LUO	04/27/2021
SONY AKKARAKARAN	04/26/2021
JUNYI LI	05/01/2021
TAESANG YOO	05/06/2021
QIANG WU	04/26/2021
ARUMUGAM CHENDAMARAI KANNAN	05/05/2021
JINGCHAO BAO	04/30/2021

RECEIVING PARTY DATA

Name:	QUALCOMM INCORPORATED
Street Address:	5775 MOREHOUSE DRIVE
City:	SAN DIEGO
State/Country:	CALIFORNIA
Postal Code:	92121

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	17238141

CORRESPONDENCE DATA

Fax Number:

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 713 623 4844

Email: rross@pattersonsheridan.com, psdocketing@pattersonsheridan.com

Correspondent Name: PATTERSON + SHERIDAN, L.L.P. QUALCOMM

Address Line 1: 24 GREENWAY PLAZA, SUITE 1600

Address Line 4: HOUSTON, TEXAS 77046

ATTORNEY DOCKET NUMBER:	203984US
NAME OF SUBMITTER:	MARCUS W. HAMMACK
SIGNATURE:	/MARCUS W. HAMMACK/

PATENT 506650787 REEL: 056167 FRAME: 0162

DATE SIGNED:	05/07/2021				
Total Attachments: 10					
source=203984_ASSIGNMENT#page1.	tif				
source=203984_ASSIGNMENT#page2.	tif				
source=203984_ASSIGNMENT#page3.	tif				
source=203984_ASSIGNMENT#page4.	tif				
source=203984_ASSIGNMENT#page5.	tif				
source=203984_ASSIGNMENT#page6.	tif				
source=203984_ASSIGNMENT#page7.	source=203984_ASSIGNMENT#page7.tif				
source=203984_ASSIGNMENT#page8.tif					
source=203984_ASSIGNMENT#page9.tif					
source=203984_ASSIGNMENT#page10.tif					

ASSIGNMENT

WHEREAS, WE,

- 1. **Hamed PEZESHKI**, having a mailing address located at 5775 Morehouse Drive; San Diego, California 92121-1714,
- 2. **Tao LUO**, having a mailing address located at 5775 Morehouse Drive; San Diego, California 92121-1714,
- 3. **Sony AKKARAKARAN**, having a mailing address located at 5775 Morehouse Drive; San Diego, California 92121-1714,
- 4. **Junyi LI**, having a mailing address located at 5775 Morehouse Drive; San Diego, California 92121-1714,
- 5. **Taesang YOO**, having a mailing address located at 5775 Morehouse Drive; San Diego, California 92121-1714,
- 6. **Qiang WU**, having a mailing address located at 5775 Morehouse Drive; San Diego, California 92121-1714,
- 7. **Arumugam CHENDAMARAI KANNAN**, having a mailing address located at 5775 Morehouse Drive; San Diego, California 92121-1714,
- 8. **Jingchao BAO**, having a mailing address located at 5775 Morehouse Drive; San Diego, California 92121-1714.

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to **REPORTING QUANTIZED USER EQUIPMENT (UE) ORIENTATION FOR BEAM SELECTION** (collectively the "**INVENTIONS**") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, **QUALCOMM Incorporated** (hereinafter "**ASSIGNEE**"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not

limited to U.S. Application No. 17/238,141, filed April 22, 2021, Qualcomm Reference No. 203984, and all provisional applications relating thereto, together with U.S. Provisional Application No. 63/015,409, filed April 24, 2020, Qualcomm Reference No. 203984P1, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

Done at	San Olego, CA	, on	04/26/2021	Homed Germ
	CITY, STATE	,	DATE	Hamed PEZESHKI
Done at	CITY, STATE	, on	DATE	Tao LUO
Done at	CITY, STATE	, on	DATE	Sony AKKARAKARAN
Done at	CITY, STATE	, on	DATE	Junyi LI
Done at	CITY, STATE	, on	DATE	Taesang YOO

(Ane a	CHY STATE	DATE	Hamed PEZESHKI	
Danie Mary	Children Con	40	Tao LLO	
Done at	on. TIV STATE	DATE	Sony AKKARAKARAN	
Done at	CHA SIAU ou	DATE	Junyi I. I	
Donest	CITY STATE	DATE	Taesang YOO	

Done at		, on		_	
	CITY, STATE	-	DATE	Hamed PEZESHKI	
Done at	CITY, STATE	, on	DATE	Tao LUO	
Done at	Poway, CA CITY, STATE	, on	4/26/2021 DATE	Sony AKKARAKARAN	
Done at	CITY, STATE	, on	DATE	Junyi LI	
Done at	CITY, STATE	, on	DATE	Taesang YOO	

Done at	, on		
	CITY, STATE	DATE	Hamed PEZESHKI
Done at	CITY, STATE	DATE	
	CIII, SIAIE	DAIR	Tao LUO
Done at	, on		
	CITY, STATE	DATE	Sony AKKARAKARAN
Done at	Bridgesonier, M.J., on CHY, STATE	5/11/2024	
	CITY, STATE	DATE	Junyi LJ
Done at			
	CITY, STATE	DATE	Taesang YOO

	er conflicting with				iting or do any act
Done at _	CITY, STATE	, on	ATE	Hamed PEZESHKI	
Done at _	CITY, STATE	, on	PATE	Tao LUO	
Done at	CITY, STATE	, on	PATE:	Sony AKKARAKAR	AN
Done at _	CITY, STATE	, on	PATE	Junyi LI	
Done at	San Press, CA	, on	16/2021	Tassang VOO	>

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at	Son Diego, CA City, State	, en	4/26/202/ Date	Qiang WU
Done at	City, State	, on	Date	Arumugam CHENDAMARAI KANNAN
Done at	City, State	, Ģ a	Date	Jingchao BAO

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at	.08		
	City, State	Date	Qiang WU
Done at	Balley, (A)	05/05/2024	1 haningain
	City, State	Date	Arumugam CHENDAMARAI KANNAN
Done at	.00		
	City, State	Date	Jinechao RAO

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at	City, State	, on	Qiang WU
Done at	City, State	, on	Arumugam CHENDAMARAI KANNAN
Done at	<u>San Diego, CA</u> City, State	on 04/30/2021	Ting Mee R.S. Jingchan BAO

PATENT REEL: 056167 FRAME: 0173

RECORDED: 05/07/2021